

THE INITED STATES PATENT AND TRADEMARK OFFICE

Applicants:

T.R. Cundiff et al.

Attorney Docket No.: BOCO117190

Application No.: 09/826,535

Group Art Unit: 1772

Filed:

April 4, 2001

Title:

RESIN TRANSFER MOLDING PROCESS

INFORMATION DISCLOSURE STATEMENT

Seattle, Washington 98101

August 8, 2001

TO THE COMMISSIONER FOR PATENTS:

Applicants are aware of the information listed in the attached form that may be material to the prosecution of the above-identified patent application.

- This application relies, under 35 U.S.C. § 120, on the earlier filing date of prior Application No. 09/115,568, filed July 14, 1998. The references listed on the attached form were submitted to and/or cited by the Patent and Trademark Office in this prior application and, therefore, are not required to be provided in this application.
- 2. X Pursuant to 37 C.F.R. § 1.97(b), this Information Disclosure Statement is being filed within three months of the filing date of the national application (other than a CPA), within three months of the date of entry of the national stage as set forth in 37 C.F.R. § 1.491 in an international application, before the mailing date of a first Office Action after the filing of an RCE.
- The Commissioner is hereby authorized to charge any fees under 37 C.F.R. 201.16, 1.17 and 1.18 which may be required during the entire pendency of the application, or credit any overpayment, to Deposit Account No. 03-1740. This authorization also hereby includes a request for any extensions of time of the

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appropriate length required upon the filing of any reply during the entire prosecution of this application. A copy of this document is enclosed.

Respectfully submitted,

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I hereby certify that this correspondence is being deposited with the U.S. Postal Service in a sealed envelope as first class mail with postage thereon fully prepaid and addressed to the Commissioner for Patents, Washington, D.C. 20231, on the below date.

Date

8/8/01

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